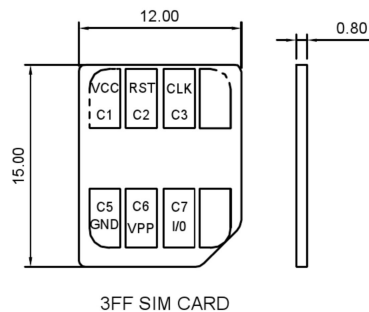
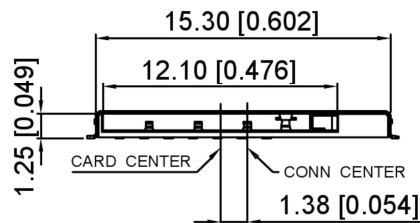
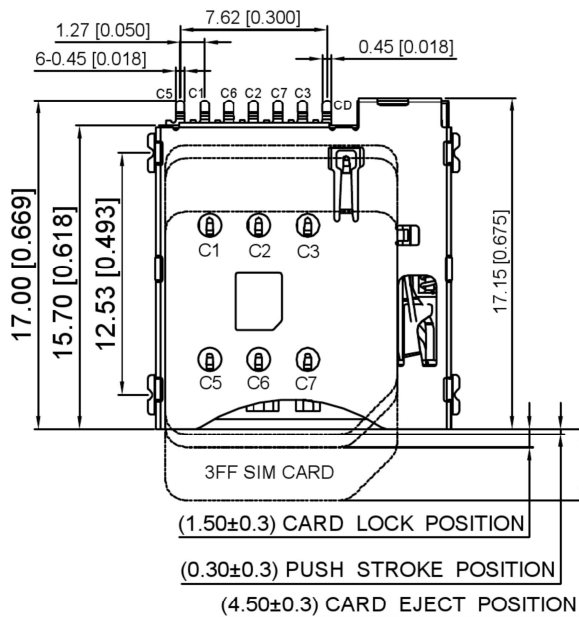


- NOTES:
- 1) MATERIAL:
HOUSING: LCP, PLASIC UL 94V-0
CONTACT: COPPER ALLOY
SHELL: STAINLESS STEEL
 - 2) FINISH:
CONTACT: GOLD FLASH PLATED ON CONTACT AREA;
GOLD FLASH PLATED ON SOLDER TAILS.
 - 3) PART NO.:
XKSMO-003-X
1: GOLD PLATED G/F

ITEM	PAPT NAMF	QTY	MATERIAL	FINISHING
③	Shell	1	SUS	
②	Terminal	7	COPPER ALLOY	
①	Housing	1	HI-TEMP. PLASIC UL 94V-0	BLACK

- CIRCUIT TRACE KEEP OUT AREA
- SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05

PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

 DONG GUAN XI BANG ELECTRONIC CO., LTD						DSND		SCALE: N/A	MODEL TYPE: SIM CARD CONN		
						DWN		VIEW: 	PART NO.: XKSIM-002-P7		
						CHKD		UNIT: mm/in	DWG NO.:		
						APPD		SIZE: A4			
						REVISIONS			UNSPECIFIED TOLERANCES		
www.alpsr.com www.gdxjdz.com www.xbswitch.com									WEIGHT	SHEET	REVISION
										1/1	A0



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